



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of

Confirmation No. 3064

Hiroaki INOUE et al.

Docket No. 2001_1094A

Serial No. 09/890,455

Filed August 1, 2001

ELECTROLESS PLATING LIQUID AND METHOD
OF FORMING INTERCONNECTION USING SUCH
AN ELECTROLESS PLATING LIQUID
[Corresponding to PCT/JP00/09099 Filed
December 21, 2000]

THE COMMISSIONER IS AUTHORIZED
TO CHARGE ANY DEFICIENCY IN THE
FEE FOR THIS PAPER TO DEPOSIT
ACCOUNT NO. 23-0975.

PETITION FOR EXTENSION OF TIME

Assistant Commissioner for Patents,
Washington, DC 20231

Sir:

Petition hereby is made for a two month extension of time to respond to the communication of
November 26, 2001.

The fee of \$400.00 is

submitted herewith.
 to be charged to Deposit Account No. 23-0975. A duplicate copy of this Petition is
enclosed.

 Small entity status of this application is established by the verified statement under 37
CFR 1.9 and 1.27 which
 is enclosed.
 has been previously submitted.

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Respectfully submitted,

Hiroaki INOUE et al.

By

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